imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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UNIT

V

Ω

nC

Taiwan Semiconductor

KEY PERFORMANCE PARAMETERS

VALUE

500

1.38

15

HALOGEN

N-Channel Power MOSFET

 $500V, 5A, 1.38\Omega$

FEATURES

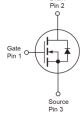
- 100% UIS and R_g tested
- Advanced planar process
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- AC/DC LED Lighting
- Power Supply
- Charger

TO-252 (DPAK)





PARAMETER

 V_{DS}

 $R_{DS(on)}\left(max
ight)$

 \mathbf{Q}_{g}

Notes: MSL 3 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER	SYMBOL	Limit	UNIT		
Drain-Source Voltage	V _{DS}	500	V		
Gate-Source Voltage	V _{GS}	±30	V		
$T_{\rm C} = 25^{\circ}$	C L	5	•		
Continuous Drain Current (Note 1) $T_c = 100$	P°C	2.2	A		
Pulsed Drain Current (Note 2)	I _{DM}	20	A		
Total Power Dissipation @ $T_{C} = 25^{\circ}C$	P _{DTOT}	83	W		
Single Pulse Avalanche Energy (Note 3)	E _{AS}	122.5	mJ		
Single Pulse Avalanche Current (Note 3)	I _{AS}	3.5	А		
Operating Junction and Storage Temperature Range	ge T _J , T _{STG}	- 55 to +150	°C		

THERMAL PERFORMANCE					
PARAMETER	SYMBOL	Limit	UNIT		
Junction to Case Thermal Resistance	R _{eJC}	1.5	°C/W		
Junction to Ambient Thermal Resistance	R _{eja}	62	°C/W		

Thermal Performance Note: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB in still air.

TSM5NC50CP



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ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250 \mu A$	BV _{DSS}	500			V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250 \mu A$	V _{GS(TH)}	2.5	3.3	4.5	V
Gate Body Leakage	$V_{GS} = \pm 30 V, \ V_{DS} = 0 V$	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	$V_{\text{DS}} = 500 V, \ V_{\text{GS}} = 0 V$	I _{DSS}			1	μA
Drain-Source On-State Resistance (Note 4)	$V_{GS} = 10V, I_D = 2.4A$	R _{DS(on)}		1.2	1.38	Ω
Dynamic (Note 5)	L			I	<u> </u>	
Total Gate Charge		Qg		15		
Gate-Source Charge	$V_{DS} = 400V, I_D = 4.8A,$	Q _{gs}		4		nC
Gate-Drain Charge	V _{GS} = 10V	Q _{gd}		7		
Input Capacitance		C _{iss}		586		
Output Capacitance	$V_{\rm DS} = 50 V, V_{\rm GS} = 0 V,$	C _{oss}		45		pF
Reverse Transfer Capacitance	f = 1.0MHz	C _{rss}		1		1
Gate Resistance	f = 1.0MHz	R _g		2.9	5.8	Ω
Switching (Note 6)						
Turn-On Delay Time		t _{d(on)}		8.2		
Turn-On Rise Time	$\begin{split} V_{\text{DD}} &= 250 V, \ R_{\text{G}} = 5 \Omega, \\ I_{\text{D}} &= 4.8 \text{A}, \ V_{\text{GS}} = 10 V \end{split}$	t _r		20.4		
Turn-Off Delay Time		t _{d(off)}		15.4		ns
Turn-Off Fall Time		t _f		20]
Source-Drain Diode						
Forward Voltage (Note 4)	$I_{\rm S} = 4.8 A, V_{\rm GS} = 0 V$	V _{SD}			1.3	V
Reverse Recovery Time	I _S = 4.8A	t _{rr}		205		ns
Reverse Recovery Charge	dl _F /dt = 100A/µs	Q _{rr}		1.5		μC

Notes:

1. Current limited by package

- 2. Pulse width limited by the maximum junction temperature
- 3. L = 20mH, I_{AS} = 3.5A, V_{DD} = 50V, R_G = 25\Omega, Starting T_J = $25^{\circ}C$
- 4. Pulse test: PW \leq 300µs, duty cycle \leq 2%
- 5. For DESIGN AID ONLY, not subject to production testing.
- 6. Switching time is essentially independent of operating temperature.

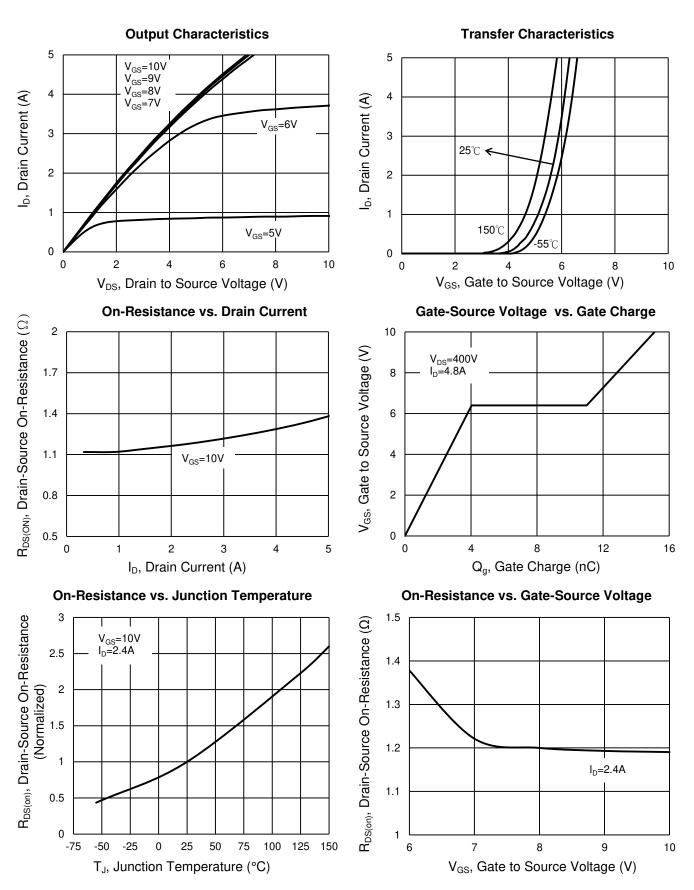
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM5NC50CP ROG	TO-252 (DPAK)	2,500pcs / 13" Reel



CHARACTERISTICS CURVES

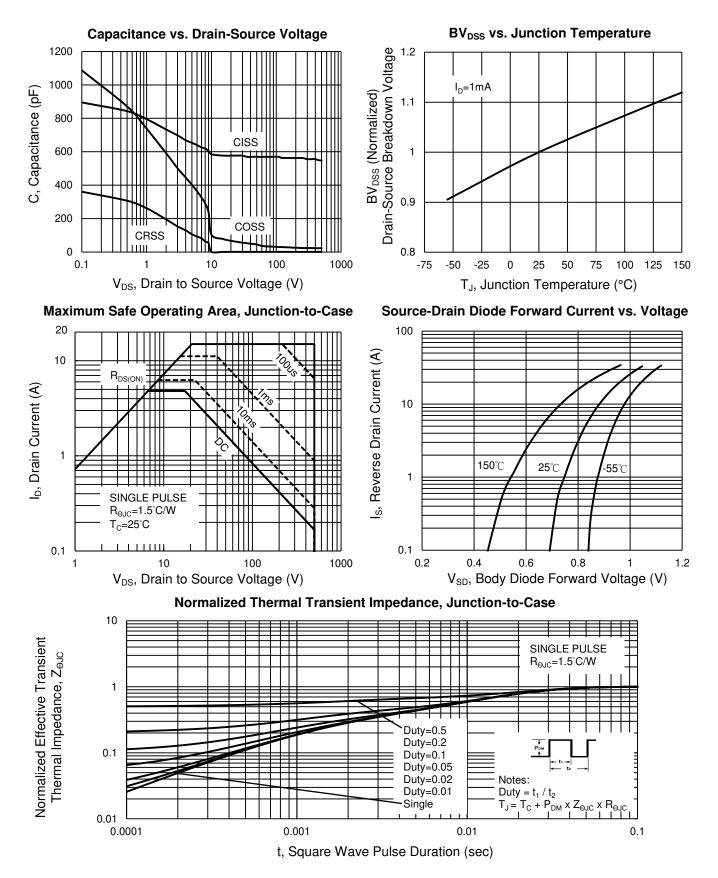
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$





CHARACTERISTICS CURVES

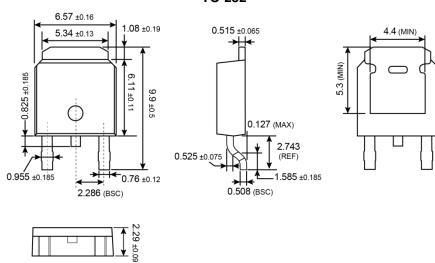
 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$



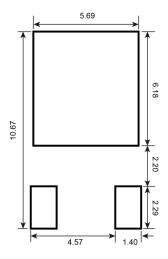




PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)



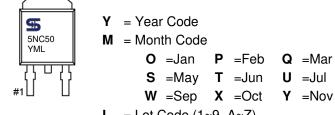
SUGGESTED PAD LAYOUT (Unit: Millimeters)



R =Apr

V =Aug Z =Dec

MARKING DIAGRAM



L = Lot Code $(1 \sim 9, A \sim Z)$



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